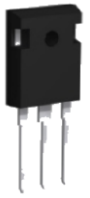
# RGCL80TS60D

**600V 40A Field Stop Trench IGBT** Data Sheet

| | |
|---|---|
| $V_{CES}$ | 600V |
| $I_{C(100°C)}$ | 40A |
| $V_{CE(sat)}$ (Typ.) | 1.4V |
| $P_D$ | 148W |

## ●Outline

TO-247N



(1)(2)(3)

## ●Features

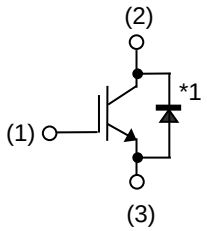
1) Low Collector - Emitter Saturation Voltage

2) Soft Switching

3) Built in Very Fast & Soft Recovery FRD
(RFN - Series)

4) Pb - free Lead Plating ; RoHS Compliant

## ●Inner Circuit




(1) Gate
(2) Collector
(3) Emitter

*1 Built in FRD

## ●Applications

Partial Switching PFC

Discharge Circuit

Brake for Inverter

## ●Packaging Specifications

| | | |
|---|---|---|
| Type | Packaging | Tube |
| | Reel Size (mm) | - |
| | Tape Width (mm) | - |
| | Basic Ordering Unit (pcs) | 450 |
| | Taping Code | C11 |
| | Marking | RGCL80TS60D |

## ●Absolute Maximum Ratings (at $T_C$ = 25°C unless otherwise specified)

| Parameter | | Symbol | Value | Unit |
|---|---|---|---|---|
| Collector - Emitter Voltage | | $V_{CES}$ | 600 | V |
| Gate - Emitter Voltage | | $V_{GES}$ | ±30 | V |
| Collector Current | $T_C$ = 25°C | $I_C$ | 65 | A |
| | $T_C$ = 100°C | $I_C$ | 40 | A |
| Pulsed Collector Current | | $I_{CP}$ *1 | 160 | A |
| Diode Forward Current | $T_C$ = 25°C | $I_F$ | 35 | A |
| | $T_C$ = 100°C | $I_F$ | 20 | A |
| Diode Pulsed Forward Current | | $I_{FP}$ *1 | 100 | A |
| Power Dissipation | $T_C$ = 25°C | $P_D$ | 148 | W |
| | $T_C$ = 100°C | $P_D$ | 74 | W |
| Operating Junction Temperature | | $T_j$ | −40 to +175 | °C |
| Storage Temperature | | $T_{stg}$ | −55 to +175 | °C |

*1 Pulse width limited by $T_{jmax.}$


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## ●Thermal Resistance

| Parameter | Symbol | Values | | | Unit |
|---|---|---|---|---|---|
| | | Min. | Typ. | Max. | |
| Thermal Resistance IGBT Junction - Case | $R_{\theta(j-c)}$ | - | - | 1.01 | °C/W |
| Thermal Resistance Diode Junction - Case | $R_{\theta(j-c)}$ | - | - | 2.28 | °C/W |

## ●IGBT Electrical Characteristics (at $T_j$ = 25°C unless otherwise specified)

| Parameter | Symbol | Conditions | Values | | | Unit |
|---|---|---|---|---|---|---|
| | | | Min. | Typ. | Max. | |
| Collector - Emitter Breakdown Voltage | $BV_{CES}$ | $I_C$ = 10μA, $V_{GE}$ = 0V | 600 | - | - | V |
| Collector Cut - off Current | $I_{CES}$ | $V_{CE}$ = 600V, $V_{GE}$ = 0V | - | - | 10 | μA |
| Gate - Emitter Leakage Current | $I_{GES}$ | $V_{GE}$ = ±30V, $V_{CE}$ = 0V | - | - | ±200 | nA |
| Gate - Emitter Threshold Voltage | $V_{GE(th)}$ | $V_{CE}$ = 5V, $I_C$ = 30.0mA | 4.5 | 5.5 | 6.5 | V |
| Collector - Emitter Saturation Voltage | $V_{CE(sat)}$ | $I_C$ = 40A, $V_{GE}$ = 15V | | | | V |
| | | $T_j$ = 25°C | - | 1.4 | 1.8 | |
| | | $T_j$ = 175°C | - | 1.6 | - | |


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●**IGBT Electrical Characteristics** (at $T_j$ = 25°C unless otherwise specified)

| Parameter | Symbol | Conditions | Values | | | Unit |
|---|---|---|---|---|---|---|
| | | | Min. | Typ. | Max. | |
| Input Capacitance | $C_{ies}$ | $V_{CE}$ = 30V | - | 2340 | - | pF |
| Output Capacitance | $C_{oes}$ | $V_{GE}$ = 0V | - | 55 | - | |
| Reverse Transfer Capacitance | $C_{res}$ | f = 1MHz | - | 43 | - | |
| Total Gate Charge | $Q_g$ | $V_{CE}$ = 300V | - | 98 | - | nC |
| Gate - Emitter Charge | $Q_{ge}$ | $I_C$ = 40A | - | 20 | - | |
| Gate - Collector Charge | $Q_{gc}$ | $V_{GE}$ = 15V | - | 38 | - | |
| Turn - on Delay Time | $t_{d(on)}$ | $I_C$ = 40A, $V_{CC}$ = 400V | - | 53 | - | ns |
| Rise Time | $t_r$ | $V_{GE}$ = 15V, $R_G$ = 10Ω | - | 34 | - | |
| Turn - off Delay Time | $t_{d(off)}$ | $T_j$ = 25°C | - | 227 | - | |
| Fall Time | $t_f$ | Inductive Load | - | 204 | - | |
| Turn - on Switching Loss | $E_{on}$ | *Eon includes diode | - | 1.11 | - | mJ |
| Turn - off Switching Loss | $E_{off}$ | reverse recovery | - | 1.68 | - | |
| Turn - on Delay Time | $t_{d(on)}$ | $I_C$ = 40A, $V_{CC}$ = 400V | - | 48 | - | ns |
| Rise Time | $t_r$ | $V_{GE}$ = 15V, $R_G$ = 10Ω | - | 66 | - | |
| Turn - off Delay Time | $t_{d(off)}$ | $T_j$ = 175°C | - | 255 | - | |
| Fall Time | $t_f$ | Inductive Load | - | 310 | - | |
| Turn - on Switching Loss | $E_{on}$ | *Eon includes diode | - | 1.51 | - | mJ |
| Turn - off Switching Loss | $E_{off}$ | reverse recovery | - | 2.30 | - | |
| Reverse Bias Safe Operating Area | RBSOA | $I_C$ = 160A, $V_{CC}$ = 480V<br>$V_P$ = 600V, $V_{GE}$ = 15V<br>$R_G$ = 60Ω, $T_j$ = 175°C | FULL SQUARE | | | - |


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●**FRD Electrical Characteristics** (at $T_j$ = 25°C unless otherwise specified)

| Parameter | Symbol | Conditions | Values | | | Unit |
|---|---|---|---|---|---|---|
| | | | Min. | Typ. | Max. | |
| Diode Forward Voltage | $V_F$ | $I_F$ = 20A<br>$T_j$ = 25°C<br>$T_j$ = 175°C | -<br>- | 1.45<br>1.25 | 1.9<br>- | V |
| Diode Reverse Recovery Time | $t_{rr}$ | $I_F$ = 20A<br>$V_{CC}$ = 400V<br>$di_F/dt$ = 200A/μs<br>$T_j$ = 25°C | - | 58 | - | ns |
| Diode Peak Reverse Recovery Current | $I_{rr}$ | | - | 6.3 | - | A |
| Diode Reverse Recovery Charge | $Q_{rr}$ | | - | 0.20 | - | μC |
| Diode Reverse Recovery Energy | $E_{rr}$ | | - | 7.4 | - | μJ |
| Diode Reverse Recovery Time | $t_{rr}$ | $I_F$ = 20A<br>$V_{CC}$ = 400V<br>$di_F/dt$ = 200A/μs<br>$T_j$ = 175°C | - | 256 | - | ns |
| Diode Peak Reverse Recovery Current | $I_{rr}$ | | - | 10.4 | - | A |
| Diode Reverse Recovery Charge | $Q_{rr}$ | | - | 1.35 | - | μC |
| Diode Reverse Recovery Energy | $E_{rr}$ | | - | 146.5 | - | μJ |


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## ●Electrical Characteristic Curves

Fig.1 Power Dissipation vs. Case Temperature

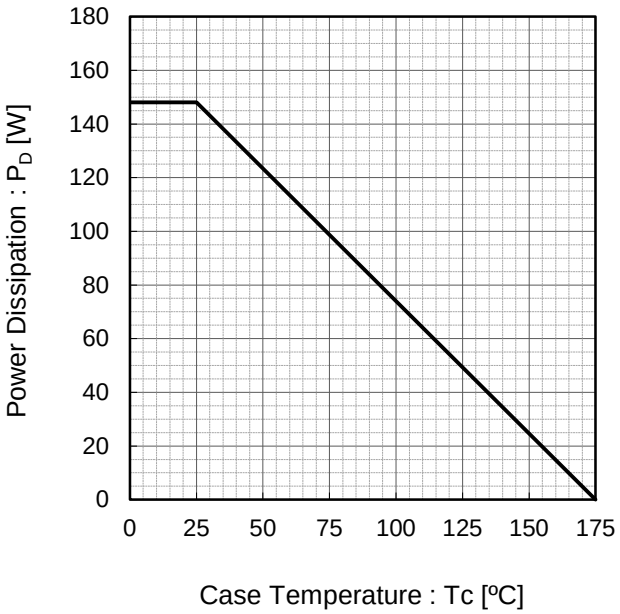



Fig.2 Collector Current vs. Case Temperature

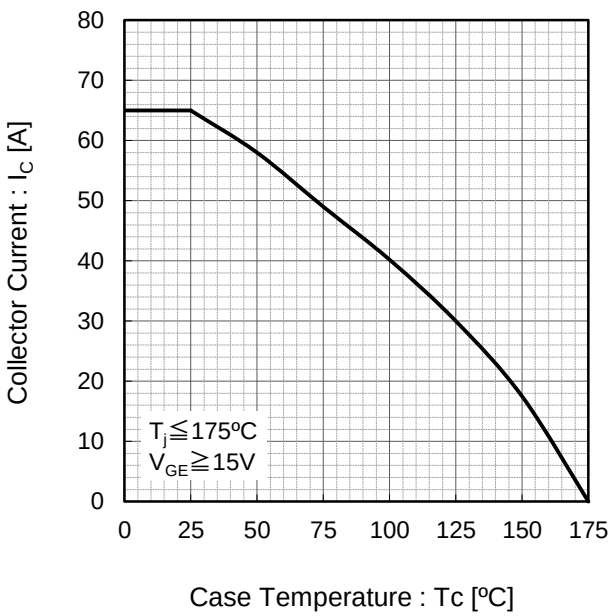



Fig.3 Forward Bias Safe Operating Area

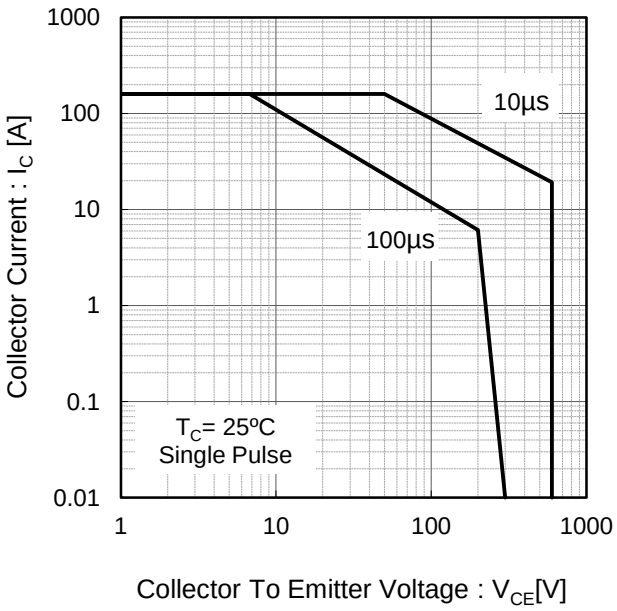
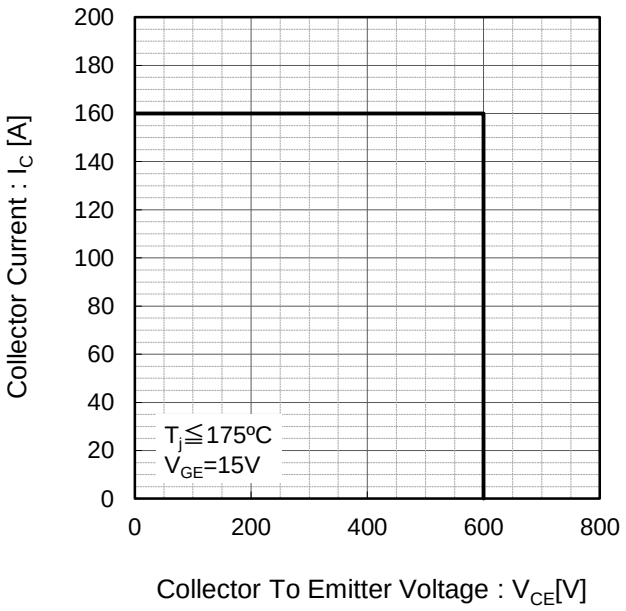



Fig.4 Reverse Bias Safe Operating Area





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## ●Electrical Characteristic Curves

Fig.5 Typical Output Characteristics

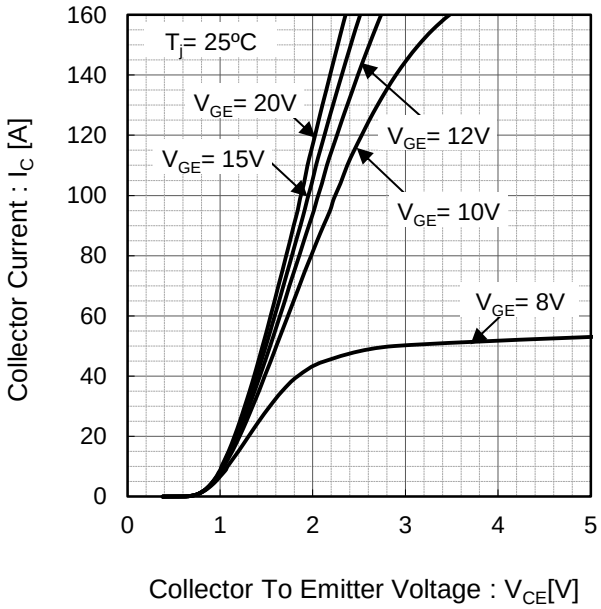



Fig.6 Typical Output Characteristics

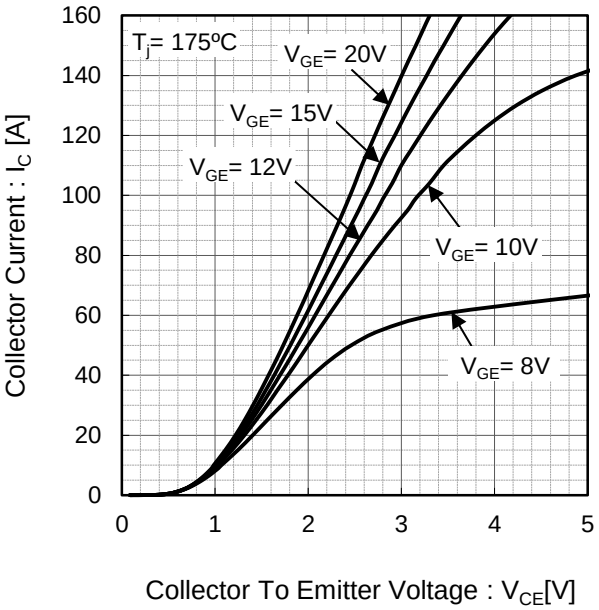



Fig.7 Typical Transfer Characteristics

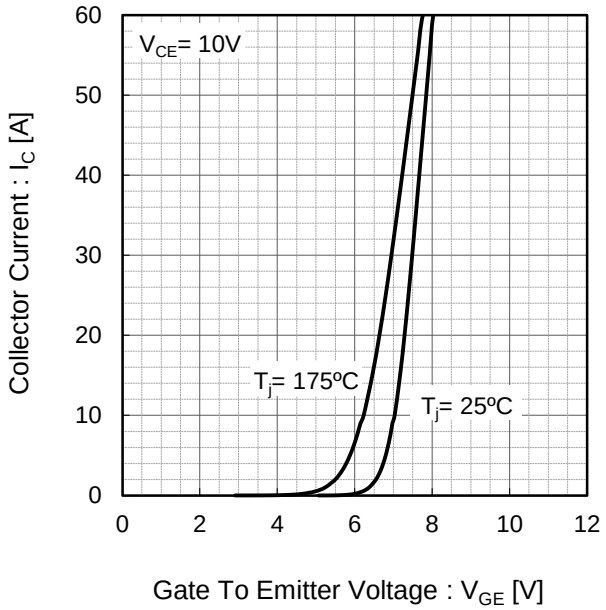
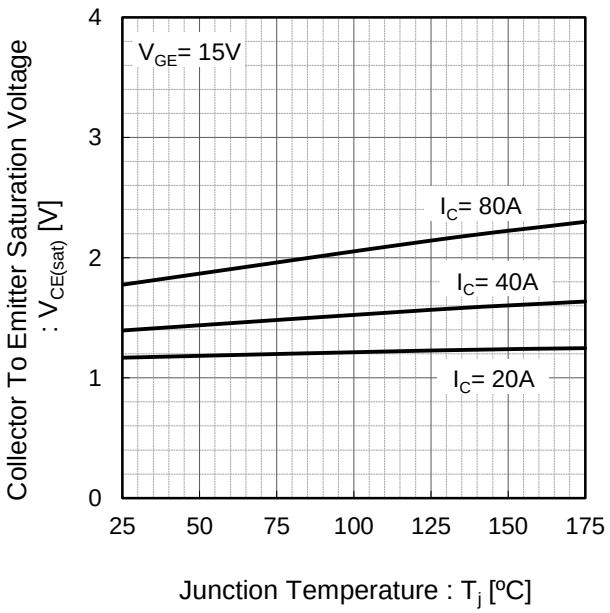



Fig.8 Typical Collector To Emitter Saturation Voltage vs. Junction Temperature





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## ●Electrical Characteristic Curves

Fig.9 Typical Collector To Emitter Saturation Voltage vs. Gate To Emitter Voltage

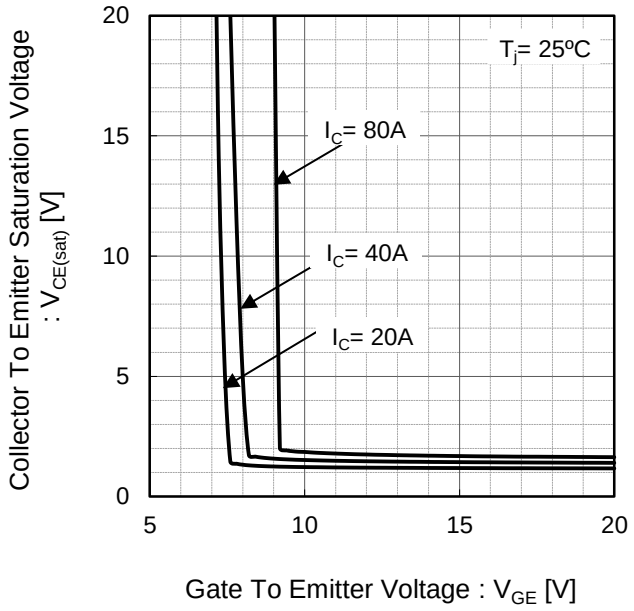



Fig.10 Typical Collector To Emitter Saturation Voltage vs. Gate To Emitter Voltage

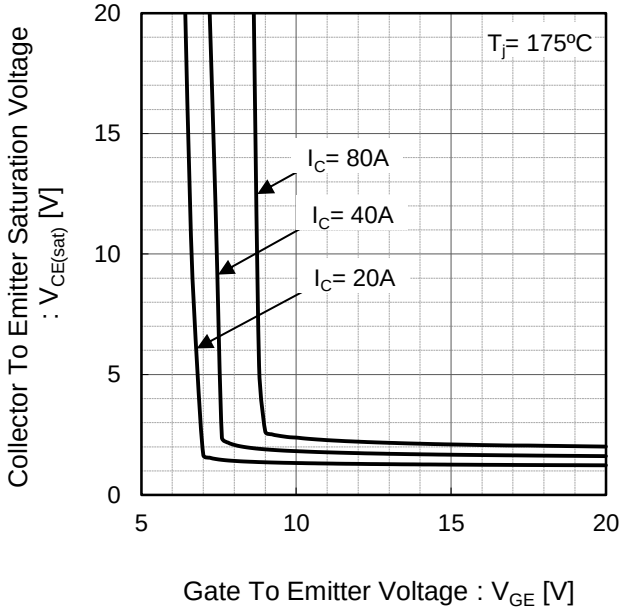



Fig.11 Typical Switching Time vs. Collector Current

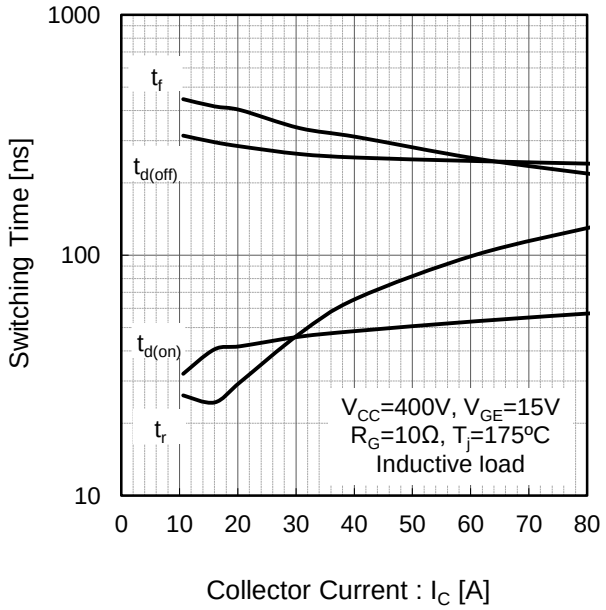
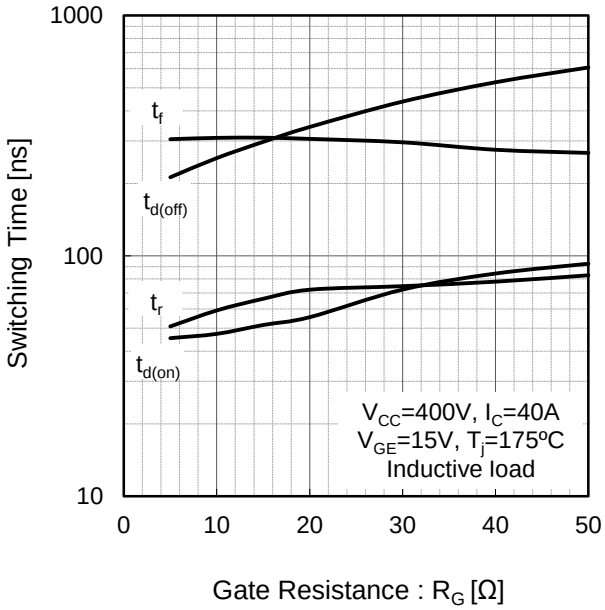



Fig.12 Typical Switching Time vs. Gate Resistance





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## ●Electrical Characteristic Curves

Fig.13 Typical Switching Energy Losses vs. Collector Current

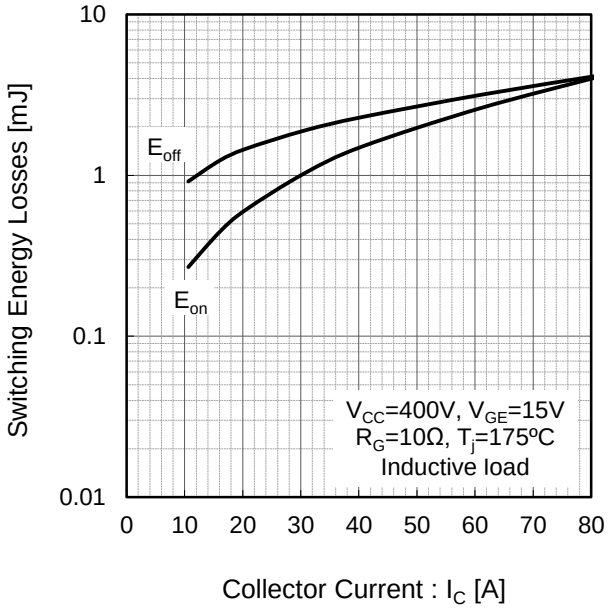



Fig.14 Typical Switching Energy Losses vs. Gate Resistance

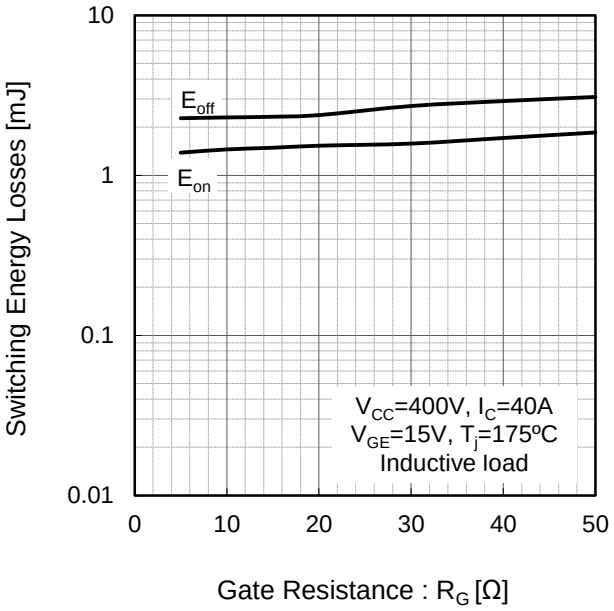



Fig.15 Typical Capacitance vs. Collector To Emitter Voltage

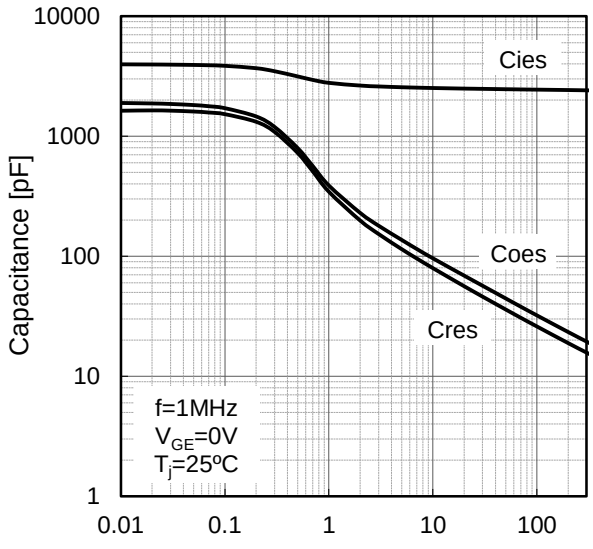
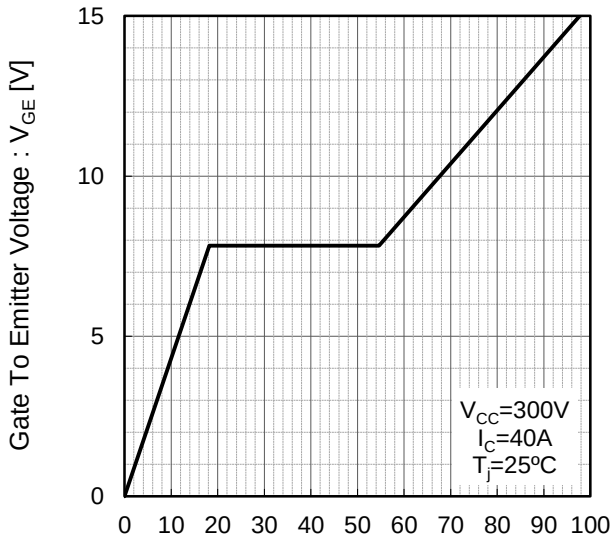



Fig.16 Typical Gate Charge





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## ●Electrical Characteristic Curves

Fig.17 Typical Diode Forward Current vs. Forward Voltage

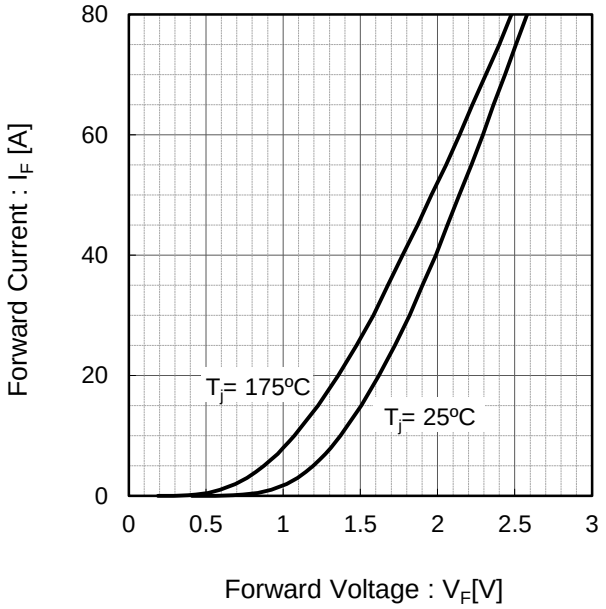



Fig.18 Typical Diode Reverse Recovery Time vs. Forward Current

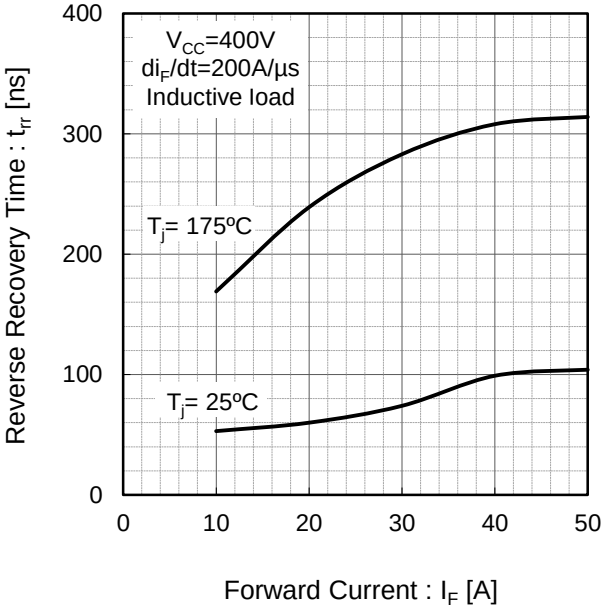



Fig.19 Typical Diode Reverse Recovery Current vs. Forward Current

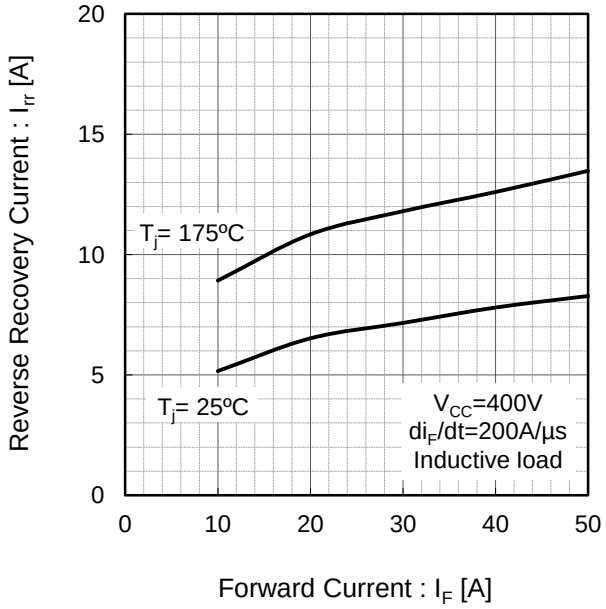
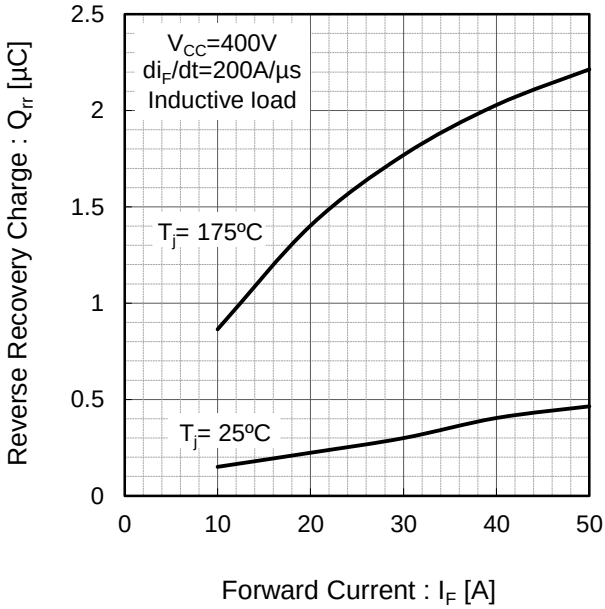



Fig.20 Typical Diode Reverse Recovery Charge vs. Forward Current





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## ●Electrical Characteristic Curves

Fig.21 IGBT Transient Thermal Impedance

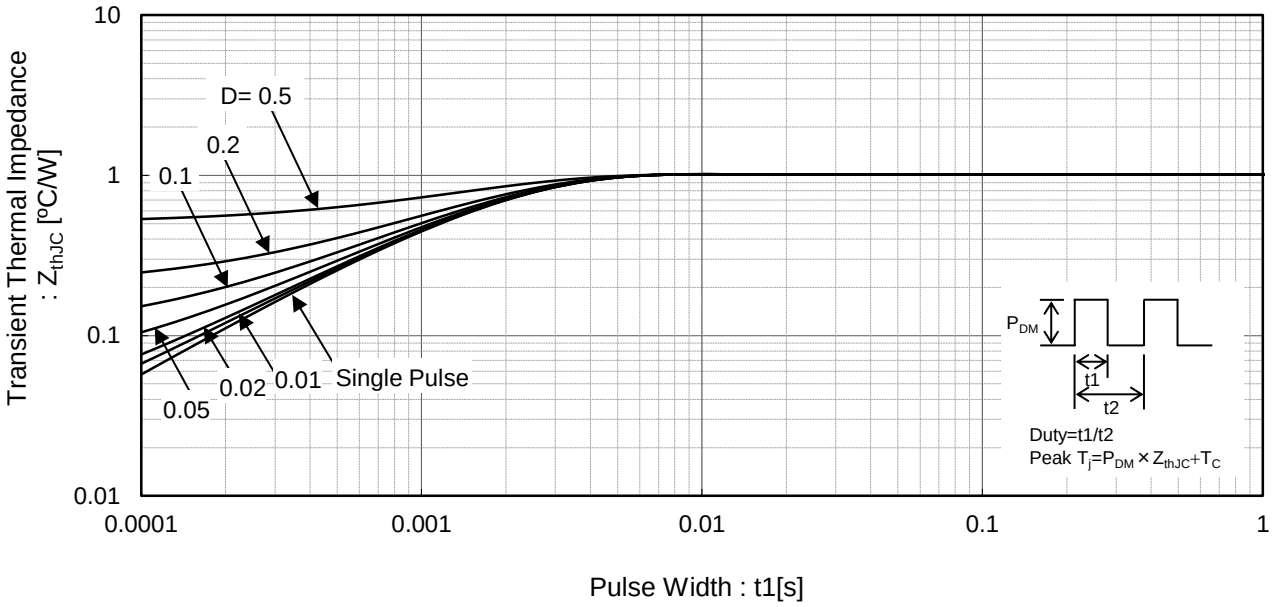
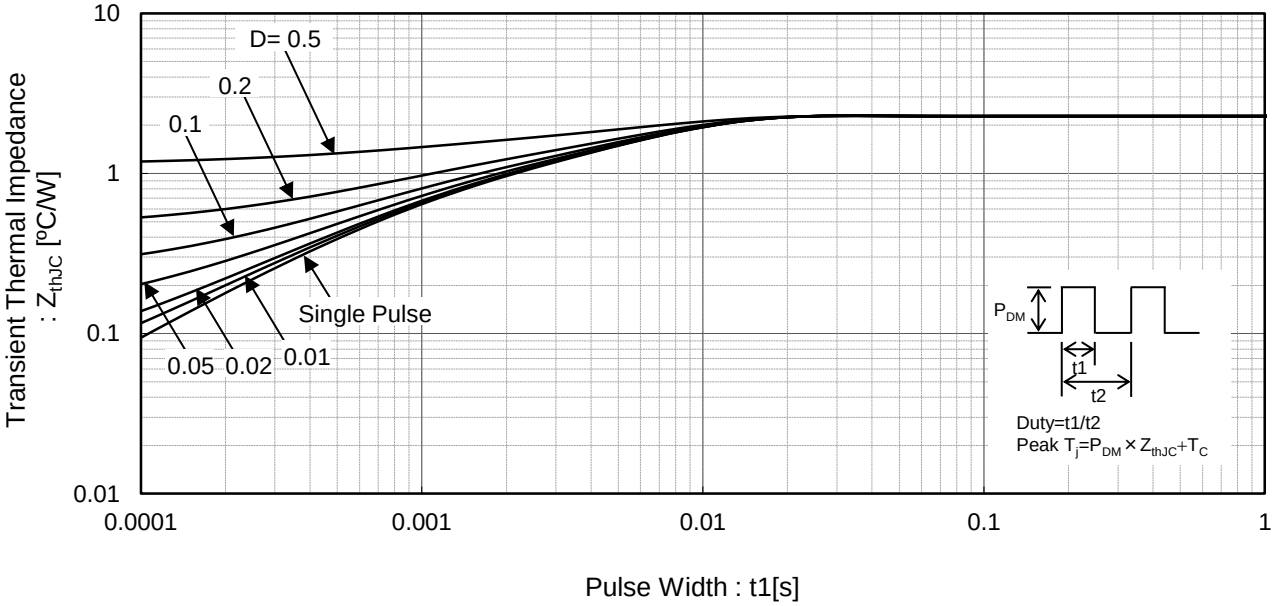



Fig.22 Diode Transient Thermal Impedance





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## ●Inductive Load Switching Circuit and Waveform

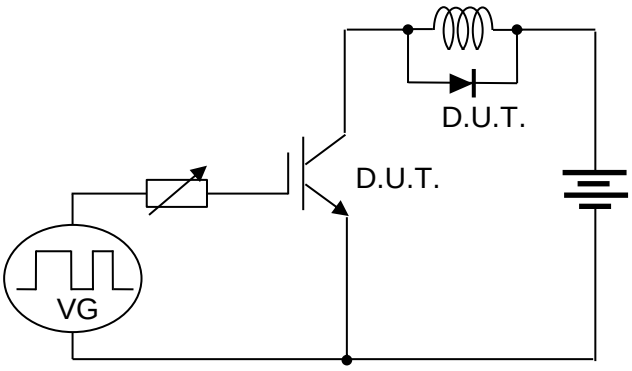



Fig.23 Inductive Load Circuit

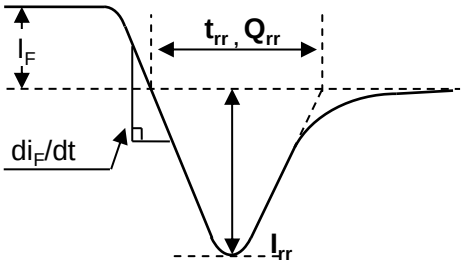



Fig.25 Diode Reverce Recovery Waveform

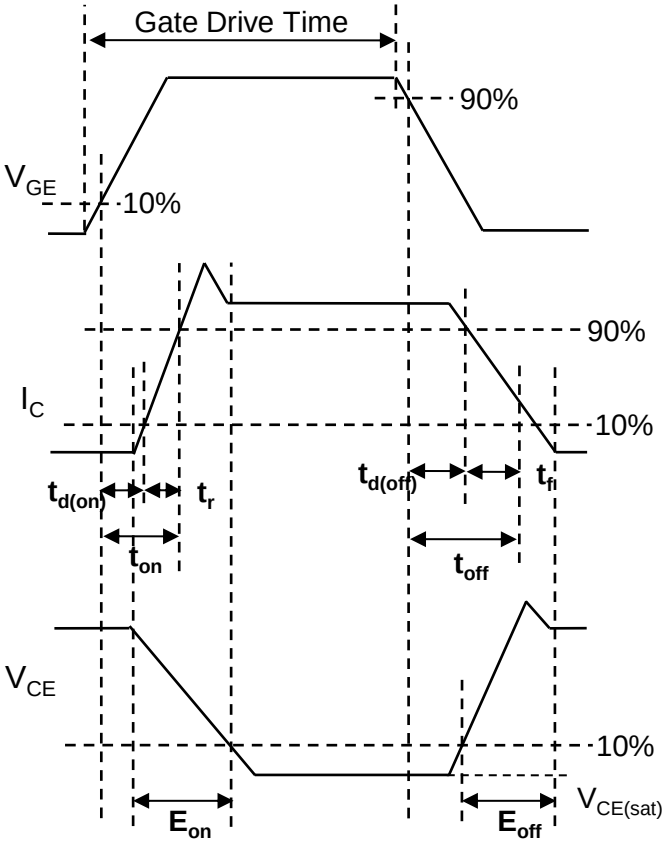



Fig.24 Inductive Load Waveform


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2) Before you use our Products, please contact our sales representative and verify the latest specifications :

3) Although ROHM is continuously working to improve product reliability and quality, semiconductors can break down and malfunction due to various factors.
Therefore, in order to prevent personal injury or fire arising from failure, please take safety measures such as complying with the derating characteristics, implementing redundant and fire prevention designs, and utilizing backups and fail-safe procedures. ROHM shall have no responsibility for any damages arising out of the use of our Poducts beyond the rating specified by ROHM.

4) Examples of application circuits, circuit constants and any other information contained herein are provided only to illustrate the standard usage and operations of the Products. The peripheral conditions must be taken into account when designing circuits for mass production.

5) The technical information specified herein is intended only to show the typical functions of and examples of application circuits for the Products. ROHM does not grant you, explicitly or implicitly, any license to use or exercise intellectual property or other rights held by ROHM or any other parties. ROHM shall have no responsibility whatsoever for any dispute arising out of the use of such technical information.

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RGCL80TS60D - Web Page

Buy

Distribution Inventory

| | |
|---|---|
| Part Number | RGCL80TS60D |
| Package | TO-247N |
| Unit Quantity | 450 |
| Minimum Package Quantity | 450 |
| Packing Type | Bulk |
| Constitution Materials List | inquiry |
| RoHS | Yes |